# **ALUMINUM ELECTROLYTIC CAPACITORS**



5.5mmL Chip Type High Temperature (260°C) Reflow series





- Corresponding with 260°C peak reflow soldering Recomended reflow condition: 260°C peak 5 sec. 230°C over 60 sec. 2 times
- Chip type with 5.5mm height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- ●Load life of 2000 hours at 85°C
- Compliant to the RoHS directive (2002/95/EC).

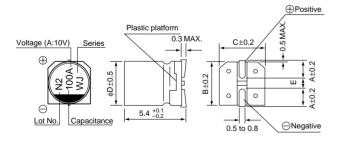




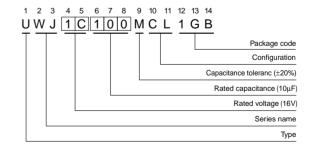
## ■Specifications

Item	Performance Characteristics											
Category Temperature Range	−40 to +85°C											
Rated Voltage Range	6.3 to 50V											
Rated Capacitance Range	0.1 to 150µF											
Capacitance Tolerance	±20% at 120Hz, 20°C											
Leakage Current	After 2 minutes' a	After 2 minutes' application of rated voltage, leakage current is not more than 0.01CV or 3 (µA) ,whichever is greater.										
			Measu	rement fr	equer	ncy : 12	0Hz, Te	mpera	ture : 20°	С		
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10	16		25	3	5	50			
	tan δ (MAX.)	0.26	0.20	0.16	5	0.14	0.1	2	0.12			
	Measurement frequency : 120Hz											
Chability at Law Taganasatura	Rated voltage (V)			6.3	10	0	16	25	3	5	50	
Stability at Low Temperature	Impedance ratio	Z-25°C /		4	3		2	2	2		2	
	ZT / Z20 (MAX.)	Z-40°C /	Z+20°C	8	8		4	4	3	3	3	
	The specifications listed at right shall be met Can							Capacitance change   Within ±20% of the initial capacitance value				
Endurance	when the capacito					tan δ			200% or less than the initial specified value			
	the rated voltage i 85°C.		Leaka	ge Curre	·							
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.											
	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.						Capacitance change Withi			e Withi	n ±10% of the initial capacitance value	
Resistance to soldering							tan δ		_	Less than or equal to the initial specified value		
heat								Leakage current			Less than or equal to the initial specified value	
Marking	Black print on the	case top.										

#### ■Chip Type



Type numbering system (Example :  $16V 10\mu F$ )



Voltage	_					
V	6.3	10	16	25	35	50
Code	j	Α	С	Е	V	Н

			(mm)
φD	4	5	6.3
A	1.8	2.1	2.4
В	4.3	5.3	6.6
С	4.3	5.3	6.6
E	1.0	1.3	2.2



## **■**Dimensions

		6.	.3	1	0	1	6	2	5	3	5	5	0
Cap. (µF)	Code	0	J	1	A	1	С	1	E	1V		1H	
0.1	0R1				 		 					4	1.0
0.22	R22				 		 					4	2.0
0.33	R33				i							4	2.8
0.47	R47											4	4.0
1	010											4	8.4
2.2	2R2											4	13
3.3	3R3				i I		i i					4	17
4.7	4R7		 		 		 	4	16	4	18	5	20
10	100				 	4	23	5	27	5	29	6.3	33
22	220	4	28	5	33	5	37	6.3	42	6.3	45		
33	330	5	37	5	41	6.3	49	6.3	52				
47	470	5	45	6.3	52	6.3	58						
100	101	6.3	70	6.3	76	6.3	86					Case size	Rated
150	151	6.3	71	·	 		 					φD (mm)	ripple

Rated ripple current (mArms) at 85°C 120Hz

# • Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.70	1.00	1.17	1.36	1.50

• Taping specifications are given in page 23.

• Please refer to page 3 for the minimum order quantity.

<sup>•</sup> Recommended land size, soldering by reflow are given in page 18, 19.